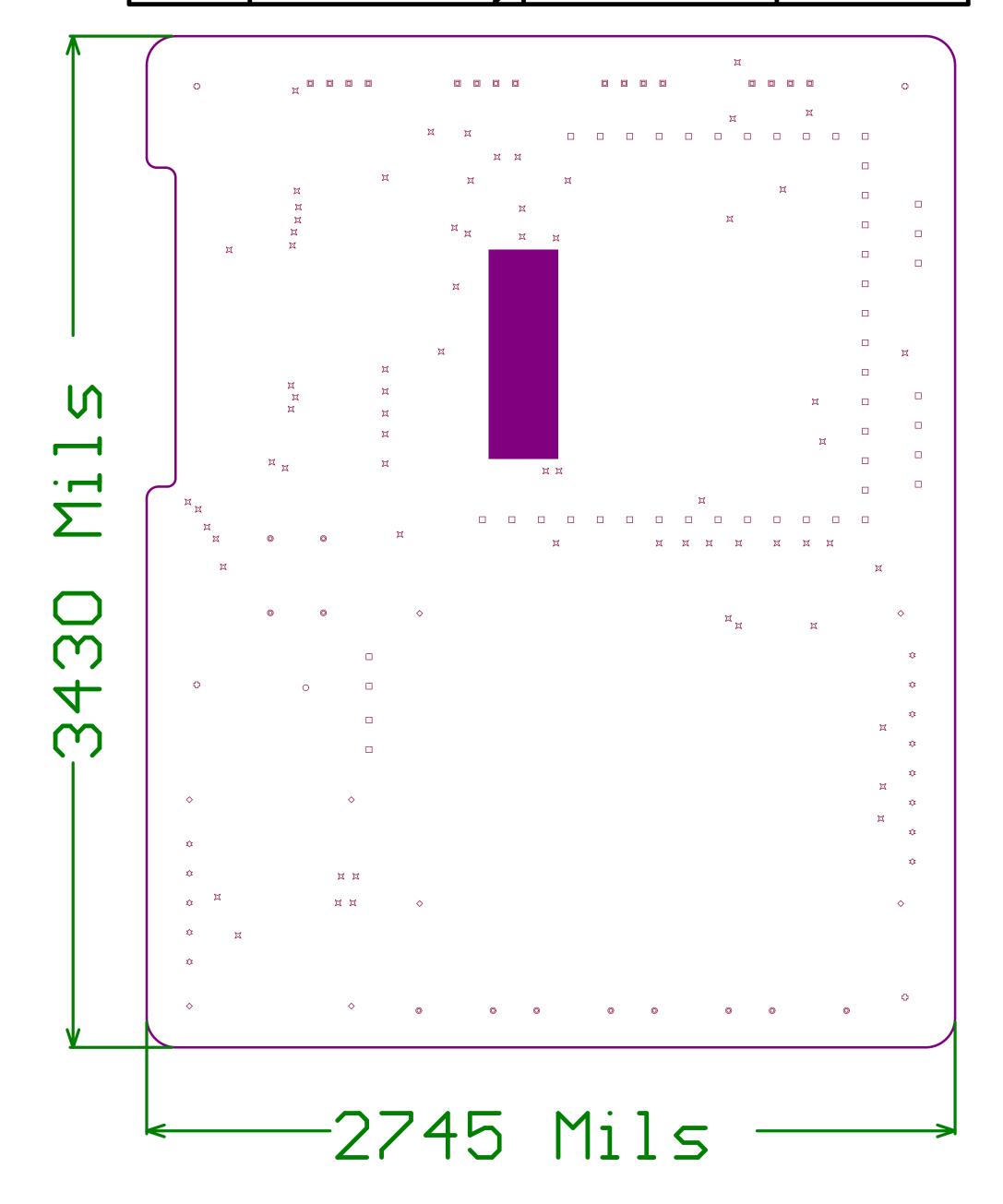
OS-2024-Badge-REV1

| Layer | Name | Material | Thickness |
|-------|----------------|---------------|-----------|
| 1 | Top Overlay | | |
| 2 | Top Solder | Solder Resist | 0.40mil |
| 3 | TOP | Copper | 1.35mil |
| 4 | Core | FR-4 | 59.5mil |
| 5 | BOTTOM | Copper | 1.35mil |
| 6 | Bottom Solder | Solder Resist | 0.40mil |
| 7 | Bottom Overlay | | |



Stackup Dimension Drill Drawing

| Symbol | Count | Hole Size | Plated |
|----------|-----------|---------------------|--------|
| 0 | 1 | 6.700mm (263.78mil) | PTH |
| 0 | 4 | 3.658mm (144.00mil) | PTH |
| ♦ | 8 | 2.000mm (78.74mil) | PTH |
| 0 | 12 | 1.200mm (47.24mil) | PTH |
| \$ | 13 | 1.800mm (70.87mil) | PTH |
| | 16 | 0.889mm (35.00mil) | PTH |
| | 48 | 0.900mm (35.43mil) | PTH |
| × | 69 | 0.381mm (15.00mil) | PTH |
| | 171 Total | | |